

Silicon Planar PIN Photodiode

EAPDSZ4439A0



Features

- Daylight filter
- High sensitivity
- Low capacitance
- Short switching time
- Wide temperature range
- Small package
- Pb free
- The product itself will remain within RoHS compliant version.

Descriptions

- EAPDSZ4439A0 is high sensitivity, fast switching times, low capacitance, compact size, and lack of measurable degradation make it suitable for diverse applications, such as TV and appliance remote control, IR sound transmission, video recorders, and measurement and control.

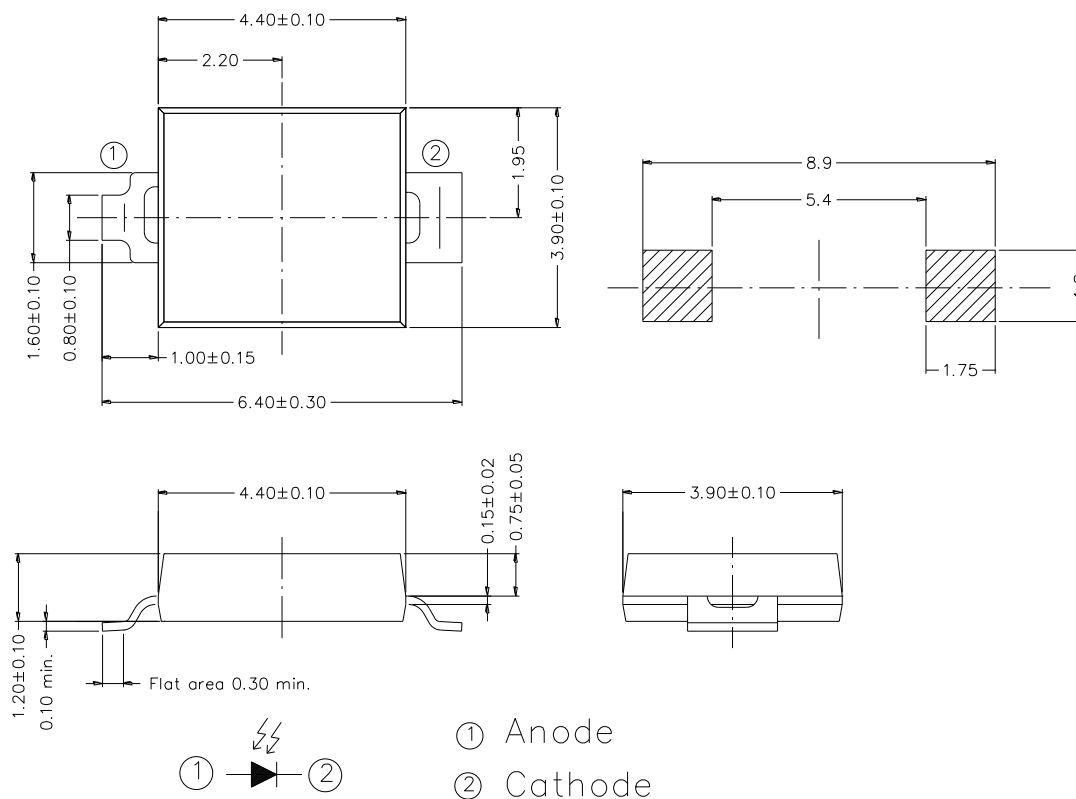
Applications

- High speed photo detector
- Copier
- Elevator

Device Selection Guide

Part Category	Chip Material	Resin Color
EAPDSZ4439A0	Silicon	Black

Package Dimensions



- Notes:** 1.All dimensions are in millimeters
2.Tolerances unless dimensions $\pm 0.1\text{mm}$

Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

Parameter	Symbol	Rating	Units
Reverse Voltage	V_R	32	V
Operating Temperature	T_{opr}	-25 ~ +85	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 ~ +85	$^\circ\text{C}$
Soldering Temperature	T_{sol}	260	$^\circ\text{C}$
Power Dissipation at(or below) 25 $^\circ\text{C}$ Free Air Temperature	P_c	150	mW

- Notes:** *1:Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Rang Of Spectral Bandwidth	λ	10% of λ_p	730	---	1100	nm
Wavelength Of Peak Sensitivity	λ_p	---	---	940	---	nm
Open-Circuit Voltage	V_{OC}	Ee=5mW/cm ² λ_p =940nm	---	0.35	0.41	V
Short- Circuit Current	I_{SC}	Ee=1mW/cm ² λ_p =940nm	---	35	---	μA
Reverse Light Current	I_L	Ee=1mW/cm ² λ_p =870nm V_R =5V	17	25	---	μA
Reverse Dark Current	I_D	Ee=0mW/cm ² V_R =10V	---	5	30	nA
Reverse Breakdown Voltage	B_{VR}	Ee=0mW/cm ² I_R =100 μA	32	170	---	V
Total Capacitance	C_t	Ee=0mW/cm ² V_R =3V f=1MHz	---	25	---	pF
Rise/Fall Time	t_r/t_f	V_R =10V R_L =1K Ω	---	50/50	---	nS

Parameter	Symbol	Value	Unit
Radiant sensitive area	A	8.0656	mm ²
Dimensions of radiant sensitive area	L×W	2.840×2.840	mm×mm
View Angle	2 θ 1/2	130	deg
Spectral sensitivity	S_λ	0.55	A/W
Forward voltage @ I_F =100mA	V_F	1.6(Max.)	V

Typical Electro-Optical Characteristics Curves

Fig.1 Power Dissipation vs.
Ambient Temperature

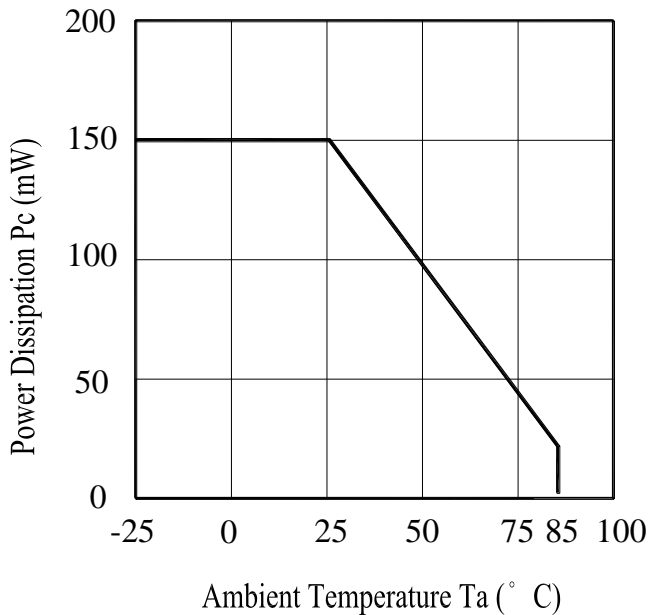


Fig.2 Spectral Sensitivity

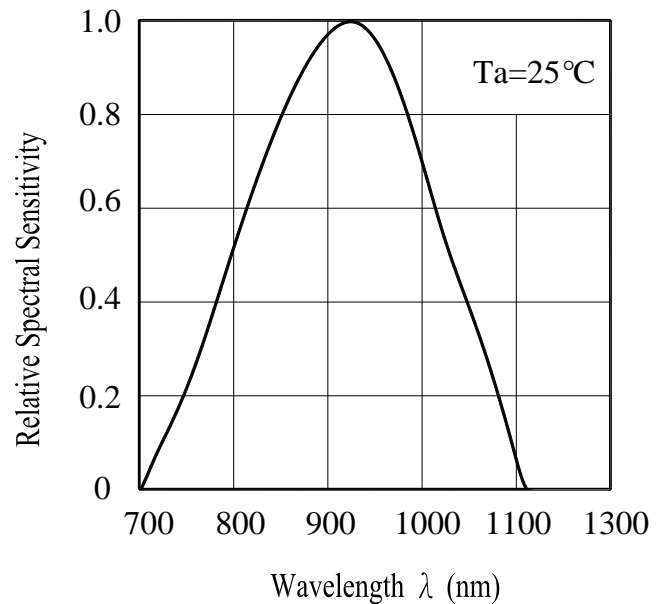


Fig.3 Dark Current vs.
Ambient Temperature

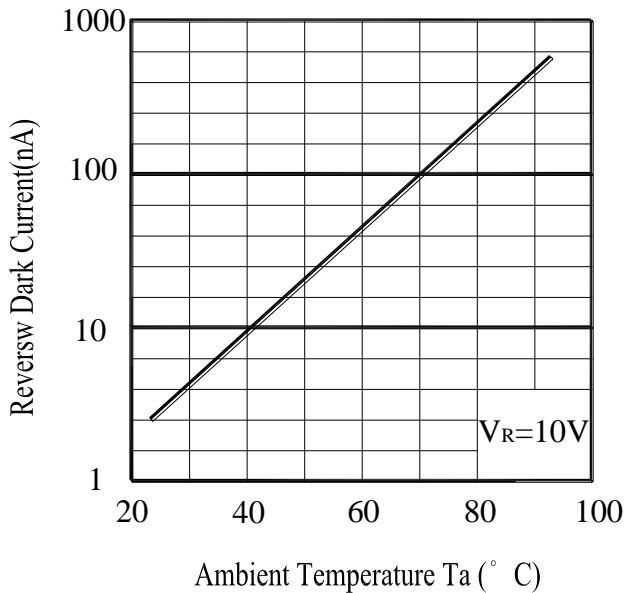
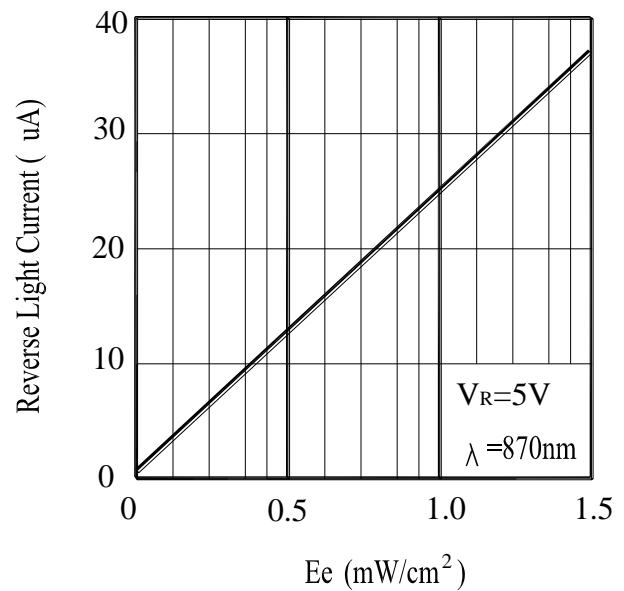


Fig. 4 Reverse Light Current vs. E_e



Typical Electro-Optical Characteristics Curves

Fig.5 Terminal Capacitance vs.
Reverse Voltage

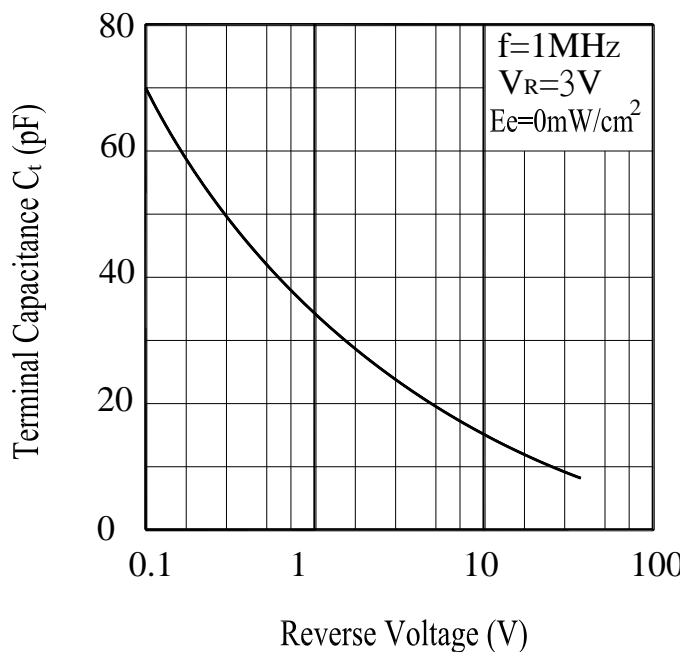
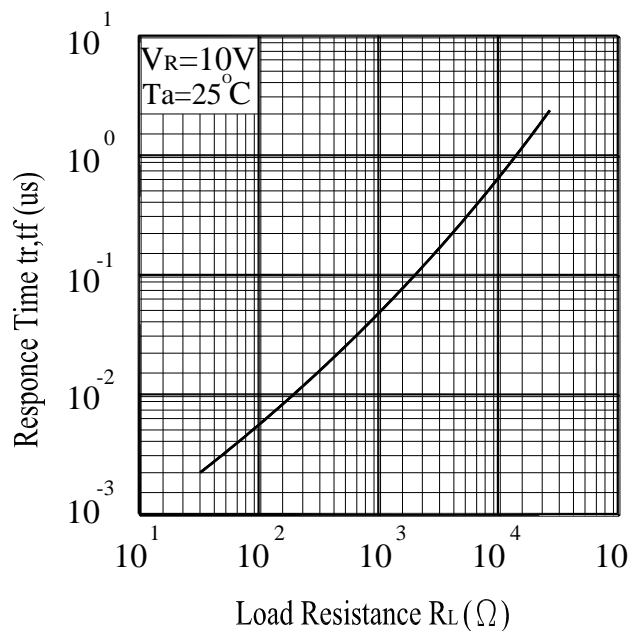


Fig.6 Response Time vs.
Load Resistance



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.

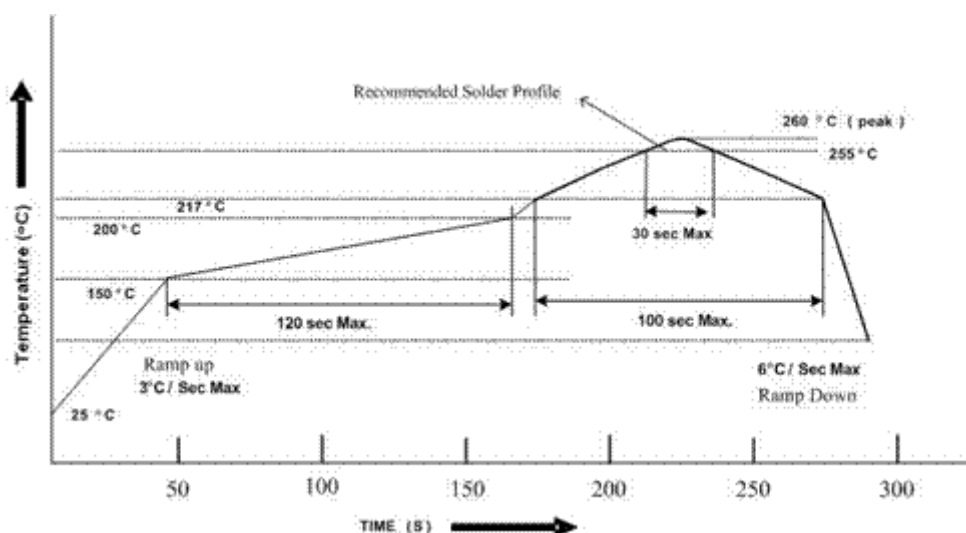
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 48 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

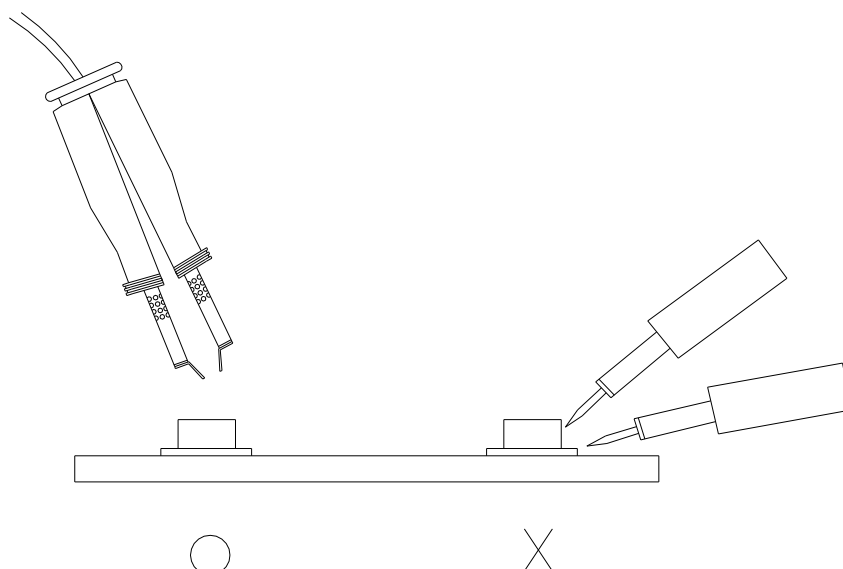
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

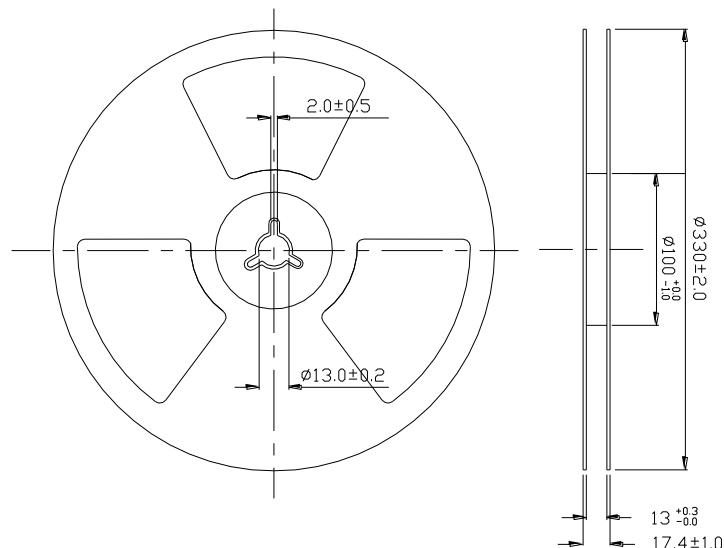
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



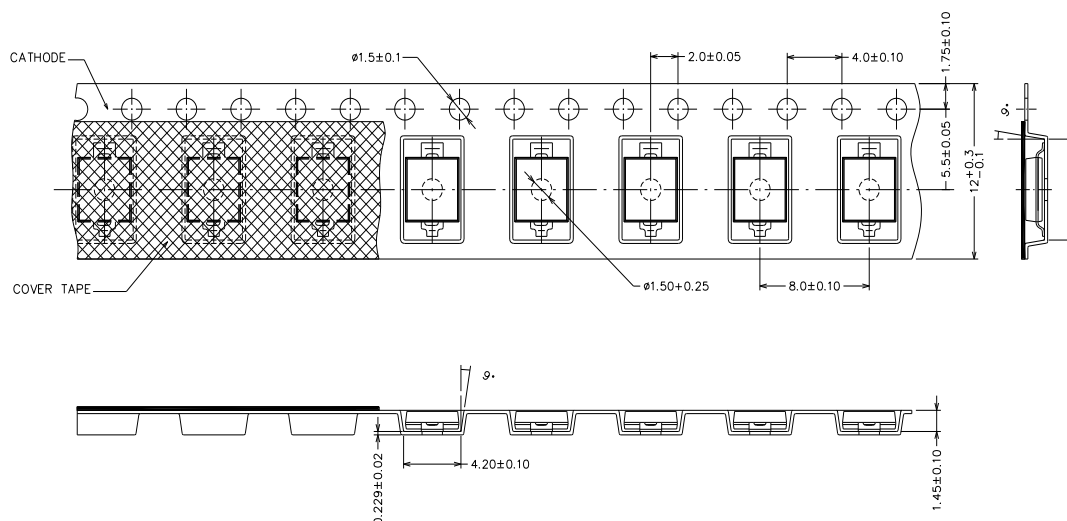
Package Dimensions

1. Reel Dimensions



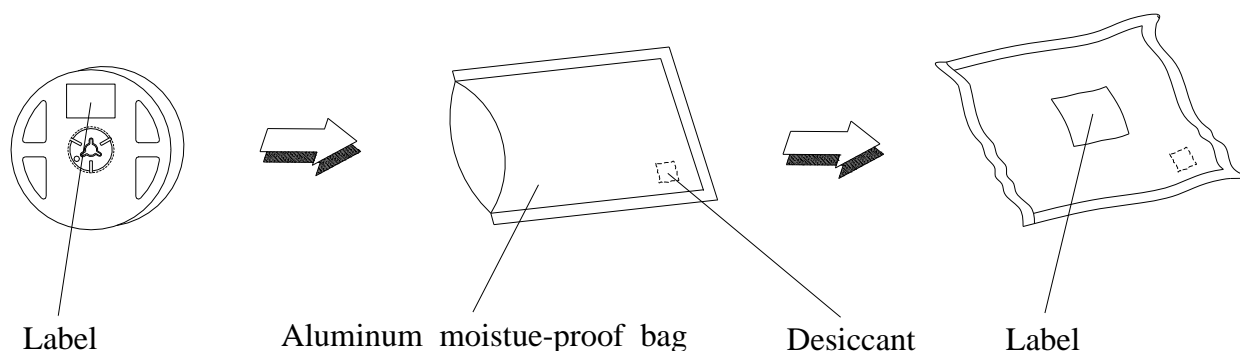
Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

2. Carrier Tape Dimensions: (Quantity: 4700pcs/reel)



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Packing Procedure



Label Form Specification

	EVERLIGHT AMERICA	
CPN: XXXXXXXXXXXX		
P/N: XXXXXXXXXXXX		
		RoHS
XXXXXXXXXXXXXXXXXXXX		
QTY: XXXX	CAT: XXX	
	HUE: XXX	
	REF: XXX	
LOT NO: XXXXXXXXXXXXXXXXXXXX		
REFERENCE: XXXXXXXXXXXX		
MADE IN TAIWAN		

CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

Notes

1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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